

December 1992

CMOS Quad Low-to-High Voltage Level Shifter

Features

- High Voltage Type (20V Rating)
- Independence of Power Supply Sequence Considerations
 - VCC can Exceed VDD
 - Input Signals can Exceed Both VCC and VDD
- Up and Down Level Shifting Capability
- Three-State Outputs with Separate Enable Controls
- 100% Tested for Quiescent Current at 20V
- 5V, 10V and 15V Parametric Ratings
- Maximum Input Current of 1 μ A at 18V Over Full Package Temperature Range; 100nA at 18V and +25°C
- Noise Margin (Over Full Package/Temperature Range)
 - 1V at VCC = 5V, VDD = 10V
 - 2V at VCC = 10V, VDD = 15V
- Standardized Symmetrical Output Characteristics
- Meets All Requirements of JEDEC Tentative Standard No. 13B, "Standard Specifications for Description of 'B' Series CMOS Devices"

Applications

- High or Low Level Shifting with Three-State Outputs for Unidirectional or Bidirectional Bussing
- Isolation of Logic Subsystems Using Separate Power Supplies from Supply Sequencing, Supply Loss and Supply Regulation Considerations

Description

CD40109BMS contains four low-to-high voltage level shifting circuits. Each circuit will shift a low voltage digital logic input signal (A, B, C, D) with logical 1 = VCC and logical 0 = VSS to a higher voltage output signal (E, F, G, H) with logical 1 = VDD and logical 0 = VSS.

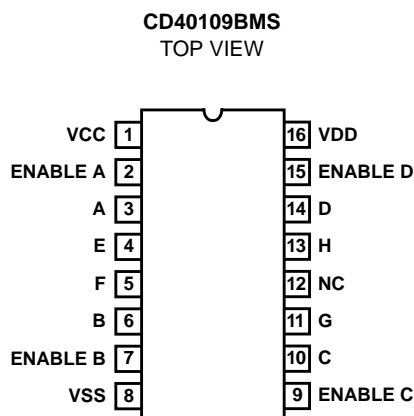
The CD40109BMS, unlike other low-to-high level shifting circuits, does not require the presence of the high voltage supply (VDD) before the application of either the low voltage supply (VCC) or the input signals. There are no restrictions on the sequence of application of VDD, VCC, or the input signals. In addition, with one exception there are no restrictions on the relative magnitudes of the supply voltages or input signals within the device maximum ratings, provided that the input signal swings between VSS and at least 0.7VCC; VCC may exceed VDD, and input signals may exceed VCC and VDD. When operated in the mode VCC > VDD, the CD40109BMS will operate as a high-to-low level shifter.

The CD40109BMS also features individual three-state output capability. A low level on any of the separately enabled three-state output controls produces a high impedance state in the corresponding output.

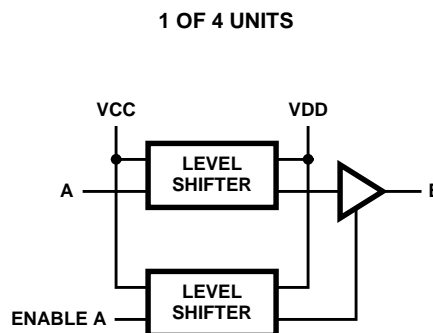
The CD40109BMS is supplied in these 16-lead outline packages:

| | |
|------------------|-----|
| Braze Seal DIP | H4T |
| Frit Seal DIP | H1E |
| Ceramic Flatpack | H6W |

Pinout



Functional Diagram



Specifications CD40109BMS

Absolute Maximum Ratings

DC Supply Voltage Range, (VDD) -0.5V to +20V
 (Voltage Referenced to VSS Terminals)
 Input Voltage Range, All Inputs -0.5V to VDD +0.5V
 DC Input Current, Any One Input $\pm 10\text{mA}$
 Operating Temperature Range -55°C to $+125^{\circ}\text{C}$
 Package Types D, F, K, H
 Storage Temperature Range (TSTG) -65°C to $+150^{\circ}\text{C}$
 Lead Temperature (During Soldering) $+265^{\circ}\text{C}$
 At Distance $1/16 \pm 1/32$ Inch ($1.59\text{mm} \pm 0.79\text{mm}$) from case for
 10s Maximum

Reliability Information

Thermal Resistance θ_{ja} θ_{jc}
 Ceramic DIP and FRIT Package 80°C/W 20°C/W
 Flatpack Package 70°C/W 20°C/W
 Maximum Package Power Dissipation (PD) at $+125^{\circ}\text{C}$
 For $T_A = -55^{\circ}\text{C}$ to $+100^{\circ}\text{C}$ (Package Type D, F, K) 500mW
 For $T_A = +100^{\circ}\text{C}$ to $+125^{\circ}\text{C}$ (Package Type D, F, K) Derate
 Linearity at $12\text{mW}/^{\circ}\text{C}$ to 200mW
 Device Dissipation per Output Transistor 100mW
 For $T_A = \text{Full Package Temperature Range (All Package Types)}$
 Junction Temperature $+175^{\circ}\text{C}$

TABLE 1. DC ELECTRICAL PERFORMANCE CHARACTERISTICS

| PARAMETER | SYMBOL | CONDITIONS (NOTE 1) | | GROUP A SUBGROUPS | TEMPERATURE | LIMITS | | UNITS |
|--------------------------------|--------|--|-----------|----------------------|--|----------------|----------------|---------------|
| | | | | | | MIN | MAX | |
| Supply Current | IDD | VDD = 20V, VIN = VDD or GND | | 1 | $+25^{\circ}\text{C}$ | - | 2 | μA |
| | | | | 2 | $+125^{\circ}\text{C}$ | - | 200 | μA |
| | | VDD = 18V, VIN = VDD or GND | | 3 | -55°C | - | 2 | μA |
| Input Leakage Current | IIL | VIN = VDD or GND | VDD = 20 | 1 | $+25^{\circ}\text{C}$ | -100 | - | nA |
| | | | | 2 | $+125^{\circ}\text{C}$ | -1000 | - | nA |
| | | | VDD = 18V | 3 | -55°C | -100 | - | nA |
| Input Leakage Current | IIH | VIN = VDD or GND | VDD = 20 | 1 | $+25^{\circ}\text{C}$ | - | 100 | nA |
| | | | | 2 | $+125^{\circ}\text{C}$ | - | 1000 | nA |
| | | | VDD = 18V | 3 | -55°C | - | 100 | nA |
| Output Voltage | VOL15 | VDD = 15V, No Load | | 1, 2, 3 | $+25^{\circ}\text{C}$, $+125^{\circ}\text{C}$, -55°C | - | 50 | mV |
| Output Voltage | VOH15 | VDD = 15V, No Load (Note 3) | | 1, 2, 3 | $+25^{\circ}\text{C}$, $+125^{\circ}\text{C}$, -55°C | 14.95 | - | V |
| Output Current (Sink) | IOL5 | VDD = 5V, VOUT = 0.4V | | 1 | $+25^{\circ}\text{C}$ | 0.53 | - | mA |
| Output Current (Sink) | IOL10 | VDD = 10V, VOUT = 0.5V | | 1 | $+25^{\circ}\text{C}$ | 1.4 | - | mA |
| Output Current (Sink) | IOL15 | VDD = 15V, VOUT = 1.5V | | 1 | $+25^{\circ}\text{C}$ | 3.5 | - | mA |
| Output Current (Source) | IOH5A | VDD = 5V, VOUT = 4.6V | | 1 | $+25^{\circ}\text{C}$ | - | -0.53 | mA |
| Output Current (Source) | IOH5B | VDD = 5V, VOUT = 2.5V | | 1 | $+25^{\circ}\text{C}$ | - | -1.8 | mA |
| Output Current (Source) | IOH10 | VDD = 10V, VOUT = 9.5V | | 1 | $+25^{\circ}\text{C}$ | - | -1.4 | mA |
| Output Current (Source) | IOH15 | VDD = 15V, VOUT = 13.5V | | 1 | $+25^{\circ}\text{C}$ | - | -3.5 | mA |
| N Threshold Voltage | VNTH | VDD = 10V, ISS = $-10\mu\text{A}$ | | 1 | $+25^{\circ}\text{C}$ | -2.8 | -0.7 | V |
| P Threshold Voltage | VPTH | VSS = 0V, IDD = $10\mu\text{A}$ | | 1 | $+25^{\circ}\text{C}$ | 0.7 | 2.8 | V |
| Functional | F | VDD = 2.8V, VIN = VDD or GND | | 7 | $+25^{\circ}\text{C}$ | VOH > VDD/2 | VOL < VDD/2 | V |
| | | VDD = 20V, VIN = VDD or GND | | 7 | $+25^{\circ}\text{C}$ | | | |
| | | VDD = 18V, VIN = VDD or GND | | 8A | $+125^{\circ}\text{C}$ | | | |
| | | VDD = 3V, VIN = VDD or GND | | 8B | -55°C | | | |
| Input Voltage Low (Note 2) | VIL | VDD = 10V, VOH > 9V, VOL < 1V VCC = 5V | | 1, 2, 3 | $+25^{\circ}\text{C}$, $+125^{\circ}\text{C}$, -55°C | - | 1.5 | V |
| Input Voltage High (Note 2) | VIH | VDD = 10V, VOH > 9V, VOL < 1V VCC = 5V | | 1, 2, 3 | $+25^{\circ}\text{C}$, $+125^{\circ}\text{C}$, -55°C | 3.5 | - | V |
| Input Voltage Low (Note 2) | VIL | VDD = 15V, VOH > 13.5V, VOL < 1.5V, VCC = 10V | | 1, 2, 3 | $+25^{\circ}\text{C}$, $+125^{\circ}\text{C}$, -55°C | - | 3 | V |
| Input Voltage High (Note 2) | VIH | VDD = 15V, VOH > 13.5V, VOL < 1.5V, VCC = 10V | | 1, 2, 3 | $+25^{\circ}\text{C}$, $+125^{\circ}\text{C}$, -55°C | 7 | - | V |
| Tri-State Output Leakage | IOZL | VIN = VDD or GND VOUT = 0V | VDD = 20V | 1 | $+25^{\circ}\text{C}$ | -0.4 | - | μA |
| | | | | 2 | $+125^{\circ}\text{C}$ | -12 | - | μA |
| | | | VDD = 18V | 3 | -55°C | -0.4 | - | μA |
| Tri-State Output Leakage | IOZH | VIN = VDD or GND VOUT = VDD | VDD = 20V | 1 | $+25^{\circ}\text{C}$ | - | 0.4 | μA |
| | | | | 2 | $+125^{\circ}\text{C}$ | - | 12 | μA |
| | | | VDD = 18V | 3 | -55°C | - | 0.4 | μA |

NOTES: 1. All voltages referenced to device GND, 100% testing being implemented. 3. For accuracy, voltage is measured differentially to VDD. Limit is 0.050V max.
 2. Go/No Go test with limits applied to inputs.

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TABLE 2. AC ELECTRICAL PERFORMANCE CHARACTERISTICS

| PARAMETER | SYMBOL | CONDITIONS | GROUP A SUBGROUPS | TEMPERATURE | LIMITS | | UNITS |
|---|----------------|--|----------------------|---------------|--------|-----|-------|
| | | | | | MIN | MAX | |
| Propagation Delay Data In to Out Shift Mode L-H | TPHL1 | VDD = 10V, VIN = VCC or GND VCC = 5V (Notes 1, 2) | 9 | +25°C | - | 600 | ns |
| | | | 10, 11 | +125°C, -55°C | - | 810 | ns |
| Propagation Delay Data In to Out Shift Mode L-H | TPLH1 | VDD = 10V, VIN = VCC or GND VCC = 5V (Notes 1, 2) | 9 | +25°C | - | 260 | ns |
| | | | 10, 11 | +125°C, -55°C | - | 351 | ns |
| Propagation Delay Data In to Out Shift Mode H-L | TPHL2 | VDD = 5V, VIN = VCC or GND VCC = 10V (Notes 1, 2) | 9 | +25°C | - | 500 | ns |
| | | | 10, 11 | +125°C, -55°C | - | 675 | ns |
| Propagation Delay Data In to Out Shift Mode H-L | TPLH2 | VDD = 5V, VIN = VCC or GND VCC = 10V (Notes 1, 2) | 9 | +25°C | - | 460 | ns |
| | | | 10, 11 | +125°C, -55°C | - | 621 | ns |
| Transition Time Shift Mode L-H | TTHL1 TTLH1 | VDD = 10V, VIN = VDD or GND VCC = 5V (Notes 1, 2) | 9 | +25°C | - | 100 | ns |
| | | | 10, 11 | +125°C, -55°C | - | 135 | ns |
| Transition Time Shift Mode H-L | TTHL2 TTLH2 | VDD = 5V, VIN = VDD or GND VCC = 10V (Notes 1, 2) | 9 | +25°C | - | 200 | ns |
| | | | 10, 11 | +125°C, -55°C | - | 270 | ns |
| Propagation Delay 3-State Shift Mode L-H | TPHZ1 | VDD = 10V, VIN = VCC or GND VCC = 5V (Notes 2, 3) | 9 | +25°C | - | 120 | ns |
| | | | 10, 11 | +125°C, -55°C | - | 162 | ns |
| Propagation Delay 3-State Shift Mode H-L | TPHZ2 | VDD = 5V, VIN = VCC or GND VCC = 10V (Notes 2, 3) | 9 | +25°C | - | 400 | ns |
| | | | 10, 11 | +125°C, -55°C | - | 540 | ns |
| Propagation Delay 3-State Shift Mode L-H | TPLZ1 | VDD = 10V, VIN = VCC or GND VCC = 5V (Notes 2, 3) | 9 | +25°C | - | 740 | ns |
| | | | 10, 11 | +125°C, -55°C | - | 999 | ns |
| Propagation Delay 3-State Shift Mode H-L | TPLZ2 | VDD = 5V, VIN = VCC or GND VCC = 10V (Notes 2, 3) | 9 | +25°C | - | 500 | ns |
| | | | 10, 11 | +125°C, -55°C | - | 675 | ns |
| Propagation Delay 3-State Shift Mode L-H | TPZH1 | VDD = 10V, VIN = VCC or GND VCC = 5V (Notes 2, 3) | 9 | +25°C | - | 640 | ns |
| | | | 10, 11 | +125°C, -55°C | - | 864 | ns |
| Propagation Delay 3-State Shift Mode H-L | TPZH2 | VDD = 5V, VIN = VCC or GND VCC = 10V (Notes 2, 3) | 9 | +25°C | - | 600 | ns |
| | | | 10, 11 | +125°C, -55°C | - | 810 | ns |
| Propagation Delay 3-State Shift Mode L-H | TPZL1 | VDD = 10V, VIN = VCC or GND VCC = 5V (Notes 2, 3) | 9 | +25°C | - | 200 | ns |
| | | | 10, 11 | +125°C, -55°C | - | 270 | ns |
| Propagation Delay 3-State Shift Mode H-L | TPZL2 | VDD = 5V, VIN = VCC or GND VCC = 10V (Notes 2, 3) | 9 | +25°C | - | 400 | ns |
| | | | 10, 11 | +125°C, -55°C | - | 540 | ns |

NOTES:

1. CL = 50pF, RL = 200K, Input TR, TF < 20ns.
2. -55°C and +125°C limits guaranteed, 100% testing being implemented.
3. CL = 50pF, RL = 1K, Input TR, TF < 20ns.

TABLE 3. ELECTRICAL PERFORMANCE CHARACTERISTICS

| PARAMETER | SYMBOL | CONDITIONS | NOTES | TEMPERATURE | LIMITS | | UNITS |
|----------------|--------|-----------------------------|-------|-------------------------|--------|-----|-------|
| | | | | | MIN | MAX | |
| Supply Current | IDD | VDD = 5V, VIN = VDD or GND | 1, 2 | -55°C, +25°C | - | 1 | μA |
| | | | | +125°C | - | 30 | μA |
| | | VDD = 10V, VIN = VDD or GND | 1, 2 | -55°C, +25°C | - | 2 | μA |
| | | | | +125°C | - | 60 | μA |
| | | VDD = 15V, VIN = VDD or GND | 1, 2 | -55°C, +25°C | - | 2 | μA |
| | | | | +125°C | - | 120 | μA |
| Output Voltage | VOL | VDD = 5V, No Load | 1, 2 | +25°C, +125°C, -55°C | - | 50 | mV |

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TABLE 3. ELECTRICAL PERFORMANCE CHARACTERISTICS (Continued)

| PARAMETER | SYMBOL | CONDITIONS | NOTES | TEMPERATURE | LIMITS | | UNITS |
|--|----------------|---|---------|----------------------|--------|-------|-------|
| | | | | | MIN | MAX | |
| Output Voltage | VOL | VDD = 10V, No Load | 1, 2 | +25°C, +125°C, -55°C | - | 50 | mV |
| Output Voltage | VOH | VDD = 5V, No Load | 1, 2 | +25°C, +125°C, -55°C | 4.95 | - | V |
| Output Voltage | VOH | VDD = 10V, No Load | 1, 2 | +25°C, +125°C, -55°C | 9.95 | - | V |
| Output Current (Sink) | IOL5 | VDD = 5V, VOUT = 0.4V | 1, 2 | +125°C | 0.36 | - | mA |
| | | | | -55°C | 0.64 | - | mA |
| Output Current (Sink) | IOL10 | VDD = 10V, VOUT = 0.5V | 1, 2 | +125°C | 0.9 | - | mA |
| | | | | -55°C | 1.6 | - | mA |
| Output Current (Sink) | IOL15 | VDD = 15V, VOUT = 1.5V | 1, 2 | +125°C | 2.4 | - | mA |
| | | | | -55°C | 4.2 | - | mA |
| Output Current (Source) | IOH5A | VDD = 5V, VOUT = 4.6V | 1, 2 | +125°C | - | -0.36 | mA |
| | | | | -55°C | - | -0.64 | mA |
| Output Current (Source) | IOH5B | VDD = 5V, VOUT = 2.5V | 1, 2 | +125°C | - | -1.15 | mA |
| | | | | -55°C | - | -2.0 | mA |
| Output Current (Source) | IOH10 | VDD = 10V, VOUT = 9.5V | 1, 2 | +125°C | - | -0.9 | mA |
| | | | | -55°C | - | -1.6 | mA |
| Output Current (Source) | IOH15 | VDD = 15V, VOUT = 13.5V | 1, 2 | +125°C | - | -2.4 | mA |
| | | | | -55°C | - | -4.2 | mA |
| Input Voltage Low | VIL | VDD = 10V, VOH > 9V, VOL < 1V VCC = 5V | 1, 2 | +25°C, +125°C, -55°C | - | 1.5 | V |
| Input Voltage High | VIH | VDD = 10V, VOH > 9V, VOL < 1V VCC = 5V | 1, 2 | +25°C, +125°C, -55°C | 3.5 | - | V |
| Propagation Delay Data In to Data Out Shift Mode L-H | TPHL1 | VDD = 15V, VCC = 5V | 1, 2, 3 | +25°C | - | 440 | ns |
| | | VDD = 15V, VCC = 10V | 1, 2, 3 | +25°C | - | 360 | ns |
| Propagation Delay Data In to Out Shift Mode L-H | TPLH1 | VDD = 15V, VCC = 5V | 1, 2, 3 | +25°C | - | 240 | ns |
| | | VDD = 15V, VCC = 10V | 1, 2, 3 | +25°C | - | 140 | ns |
| Propagation Delay Data In to Out Shift Mode H-L | TPHL2 | VDD = 5V, VCC = 15V | 1, 2, 3 | +25°C | - | 500 | ns |
| | | VDD = 10V, VCC = 15V | 1, 2, 3 | +25°C | - | 240 | ns |
| Propagation Delay Data In to Out Shift Mode H-L | TPLH2 | VDD = 5V, VCC = 15V | 1, 2, 3 | +25°C | - | 460 | ns |
| | | VDD = 10V, VCC = 15V | 1, 2, 3 | +25°C | - | 160 | ns |
| Transition Time Shift Mode L-H | TTHL1 TTLH1 | VDD = 15V, VCC = 5V | 1, 2, 3 | +25°C | - | 80 | ns |
| | | VDD = 15V, VCC = 10V | 1, 2, 3 | +25°C | - | 80 | ns |
| Transition Time Shift Mode H-L | TTHL2 TTLH2 | VDD = 5V, VCC = 15V | 1, 2, 3 | +25°C | - | 200 | ns |
| | | VDD = 10V, VCC = 15V | 1, 2, 3 | +25°C | - | 100 | ns |
| Propagation Delay 3-State Shift Mode L-H | TPHZ1 | VDD = 15V, VCC = 5V | 1, 2, 4 | +25°C | - | 150 | ns |
| | | VDD = 15V, VCC = 10V | 1, 2, 4 | +25°C | - | 70 | ns |
| Propagation Delay 3-State Shift Mode H-L | TPHZ2 | VDD = 5V, VCC = 5V | 1, 2, 4 | +25°C | - | 400 | ns |
| | | VDD = 10V, VCC = 15V | 1, 2, 4 | +25°C | - | 80 | ns |
| Propagation Delay 3-State Shift Mode L-H | TPLZ1 | VDD = 15V, VCC = 5V | 1, 2, 4 | +25°C | - | 600 | ns |
| | | VDD = 15V, VCC = 10V | 1, 2, 4 | +25°C | - | 500 | ns |

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TABLE 3. ELECTRICAL PERFORMANCE CHARACTERISTICS (Continued)

| PARAMETER | SYMBOL | CONDITIONS | NOTES | TEMPERATURE | LIMITS | | UNITS |
|---|--------|----------------------|---------|-------------|--------|-----|-------|
| | | | | | MIN | MAX | |
| Propagation Delay 3-State Shift Mode H-L | TPLZ2 | VDD = 5V, VCC = 15V | 1, 2, 4 | +25°C | - | 500 | ns |
| | | VDD = 10V, VCC = 15V | 1, 2, 4 | +25°C | - | 260 | ns |
| Propagation Delay 3-State Shift Mode L-H | TPZH1 | VDD = 15V, VCC = 5V | 1, 2, 4 | +25°C | - | 460 | ns |
| | | VDD = 15V, VCC = 10V | 1, 2, 4 | +25°C | - | 360 | ns |
| Propagation Delay 3-State Shift Mode H-L | TPZH2 | VDD = 5V, VCC = 15V | 1, 2, 4 | +25°C | - | 600 | ns |
| | | VDD = 10V, VCC = 15V | 1, 2, 4 | +25°C | - | 260 | ns |
| Propagation Delay 3-State Shift Mode L-H | TPZL1 | VDD = 15V, VCC = 5V | 1, 2, 4 | +25°C | - | 160 | ns |
| | | VDD = 15V, VCC = 10V | 1, 2, 4 | +25°C | - | 80 | ns |
| Propagation Delay 3-State Shift Mode H-L | TPZL2 | VDD = 5V, VCC = 15V | 1, 2, 4 | +25°C | - | 400 | ns |
| | | VDD = 10V, VCC = 15V | 1, 2, 4 | +25°C | - | 80 | ns |

NOTES:

1. All voltages referenced to device GND.
2. The parameters listed on Table 3 are controlled via design or process and are not directly tested. These parameters are characterized on initial design release and upon design changes which would affect these characteristics.
3. CL = 50pF, RL = 200K, Input TR, TF < 20ns.
4. CL = 50pF, RL = 1K, Input TR, TF < 20ns.

TABLE 4. POST IRRADIATION ELECTRICAL PERFORMANCE CHARACTERISTICS

| PARAMETER | SYMBOL | CONDITIONS | NOTES | TEMPERATURE | LIMITS | | UNITS |
|------------------------------|--------------|-----------------------------|------------|-------------|----------------|--------------------------|-------|
| | | | | | MIN | MAX | |
| Supply Current | IDD | VDD = 20V, VIN = VDD or GND | 1, 4 | +25°C | - | 7.5 | μA |
| N Threshold Voltage | VNTH | VDD = 10V, ISS = -10μA | 1, 4 | +25°C | -2.8 | -0.2 | V |
| N Threshold Voltage Delta | ΔVTN | VDD = 10V, ISS = -10μA | 1, 4 | +25°C | - | ±1 | V |
| P Threshold Voltage | VTP | VSS = 0V, IDD = 10μA | 1, 4 | +25°C | 0.2 | 2.8 | V |
| P Threshold Voltage Delta | ΔVTP | VSS = 0V, IDD = 10μA | 1, 4 | +25°C | - | ±1 | V |
| Functional | F | VDD = 18V, VIN = VDD or GND | 1 | +25°C | VOH > VDD/2 | VOL < VDD/2 | V |
| | | VDD = 3V, VIN = VDD or GND | | | | | |
| Propagation Delay Time | TPHL TPLH | VDD = 5V | 1, 2, 3, 4 | +25°C | - | 1.35 x +25°C Limit | ns |

NOTES: 1. All voltages referenced to device GND.

3. See Table 2 for +25°C limit.

2. CL = 50pF, RL = 200K, Input TR, TF < 20ns.

4. Read and Record

TABLE 5. BURN-IN AND LIFE TEST DELTA PARAMETERS +25°C

| PARAMETER | SYMBOL | DELTA LIMIT |
|-------------------------|--------|--------------------------|
| Supply Current - MSI-1 | IDD | ± 0.2μA |
| Output Current (Sink) | IOL5 | ± 20% x Pre-Test Reading |
| Output Current (Source) | IOH5A | ± 20% x Pre-Test Reading |

TABLE 6. APPLICABLE SUBGROUPS

| CONFORMANCE GROUP | MIL-STD-883 METHOD | GROUP A SUBGROUPS | READ AND RECORD |
|----------------------------|-----------------------|-------------------|------------------|
| Initial Test (Pre Burn-In) | 100% 5004 | 1, 7, 9 | IDD, IOL5, IOH5A |

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TABLE 6. APPLICABLE SUBGROUPS

| CONFORMANCE GROUP | | MIL-STD-883 METHOD | GROUP A SUBGROUPS | READ AND RECORD |
|-------------------------------|--------------|--------------------|---------------------------------------|------------------------------|
| Interim Test 1 (Post Burn-In) | | 100% 5004 | 1, 7, 9 | IDD, IOL5, IOH5A |
| Interim Test 2 (Post Burn-In) | | 100% 5004 | 1, 7, 9 | IDD, IOL5, IOH5A |
| PDA (Note 1) | | 100% 5004 | 1, 7, 9, Deltas | |
| Interim Test 3 (Post Burn-In) | | 100% 5004 | 1, 7, 9 | IDD, IOL5, IOH5A |
| PDA (Note 1) | | 100% 5004 | 1, 7, 9, Deltas | |
| Final Test | | 100% 5004 | 2, 3, 8A, 8B, 10, 11 | |
| Group A | | Sample 5005 | 1, 2, 3, 7, 8A, 8B, 9, 10, 11 | |
| Group B | Subgroup B-5 | Sample 5005 | 1, 2, 3, 7, 8A, 8B, 9, 10, 11, Deltas | Subgroups 1, 2, 3, 9, 10, 11 |
| | Subgroup B-6 | Sample 5005 | 1, 7, 9 | |
| Group D | | Sample 5005 | 1, 2, 3, 8A, 8B, 9 | Subgroups 1, 2 3 |

NOTE: 1. 5% Parametric, 3% Functional; Cumulative for Static 1 and 2.

TABLE 7. TOTAL DOSE IRRADIATION

| CONFORMANCE GROUPS | MIL-STD-883 METHOD | TEST | | READ AND RECORD | |
|--------------------|--------------------|-----------|------------|-----------------|------------|
| | | PRE-IRRAD | POST-IRRAD | PRE-IRRAD | POST-IRRAD |
| Group E Subgroup 2 | 5005 | 1, 7, 9 | Table 4 | 1, 9 | Table 4 |

TABLE 8. BURN-IN AND IRRADIATION TEST CONNECTIONS

| FUNCTION | OPEN | GROUND | VDD | 9V ± 0.5V | OSCILLATOR | |
|---------------------------|-------------|--------------------|-------------------------|--------------------------|-----------------------|----------------------|
| | | | | | 50kHz | 25kHz |
| Static Burn-In 1 (Note 1) | 4, 5, 11-13 | 2, 3, 6-10, 14, 15 | 1, 16 | | | |
| Static Burn-In 2 (Note 1) | 4, 5, 11-13 | 8 | 16 | 1-3, 4, 7, 9, 10, 14, 15 | | |
| Dynamic Burn-In (Note 4) | 12 | 8 | 16 | 1, 4, 5, 11, 13 | 3, 6, 10, 14 (Note 3) | 2, 7, 9, 15 (Note 3) |
| Irradiation (Note 2) | 4, 5, 11-13 | 8 | 1-3, 6, 7, 9, 10, 14-16 | | | |

NOTES:

- Each pin except Pin 1, VDD and GND will have a series resistor of $10K \pm 5\%$, VDD = $18V \pm 0.5V$
- Each pin except Pin 1, VDD and GND will have a series resistor of $47K \pm 5\%$; Group E, Subgroup 2, sample size is 4 dice/wafer, 0 failures, VDD = $10V \pm 0.5V$
- Pin voltage is VDD/2
- Each pin except Pin 1, VDD and GND will have a series resistor of $4.75K \pm 5\%$, VDD = $18V \pm 0.5V$.

Logic Diagram

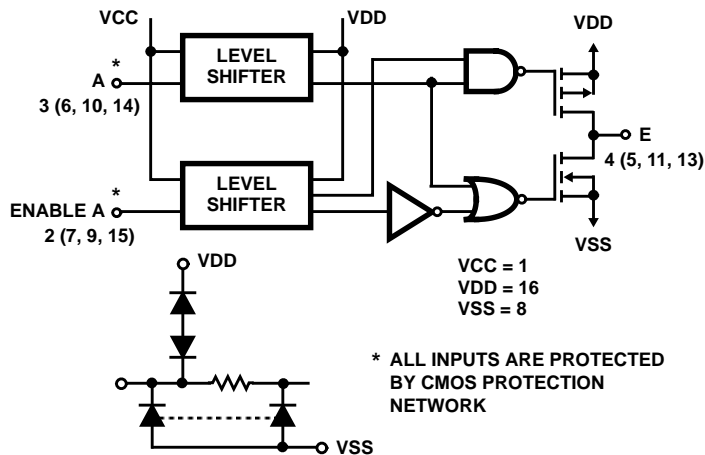


FIGURE 1. 1 OF 4 UNITS

TRUTH TABLE

| INPUTS | | OUTPUTS |
|------------|-------------------|------------|
| A, B, C, D | ENABLE A, B, C, D | E, F, G, H |
| 0 | 1 | 0 |
| 1 | 1 | 1 |
| X | 0 | Z |

Logic 0 = Low(VSS)

X = Don't care

Z = High impedance

Logic 1 = VCC at Inputs and VDD at Outputs

Typical Performance Characteristics

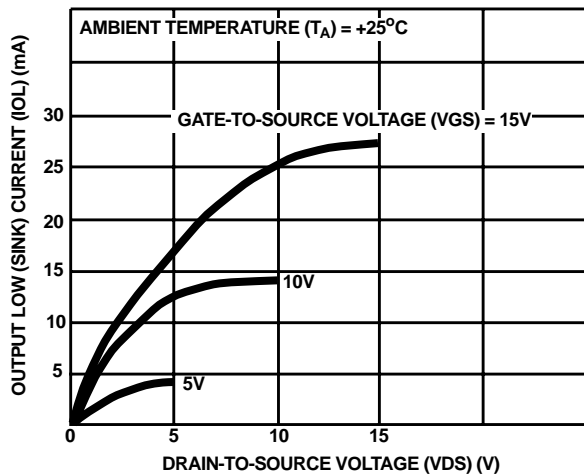


FIGURE 2. TYPICAL OUTPUT LOW (SINK) CURRENT CHARACTERISTICS

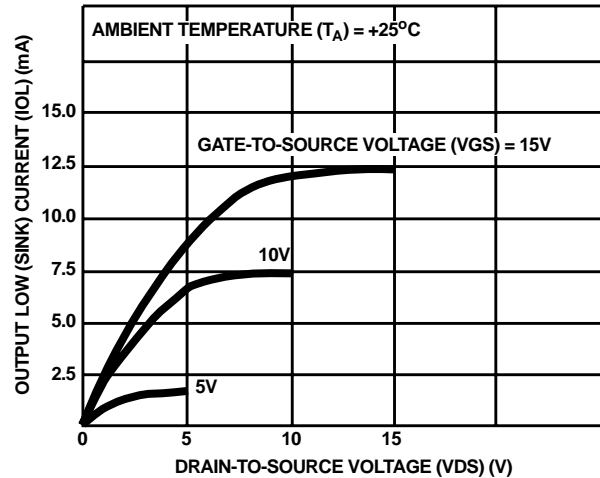


FIGURE 3. MINIMUM OUTPUT LOW (SINK) CURRENT CHARACTERISTICS

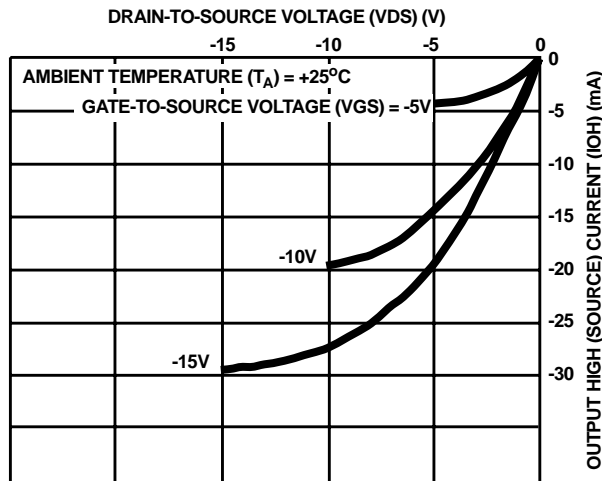


FIGURE 4. TYPICAL OUTPUT HIGH (SOURCE) CURRENT CHARACTERISTICS

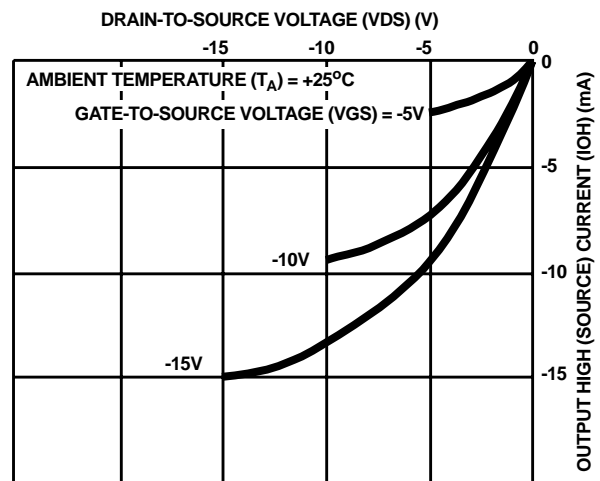


FIGURE 5. MINIMUM OUTPUT HIGH (SOURCE) CURRENT CHARACTERISTICS

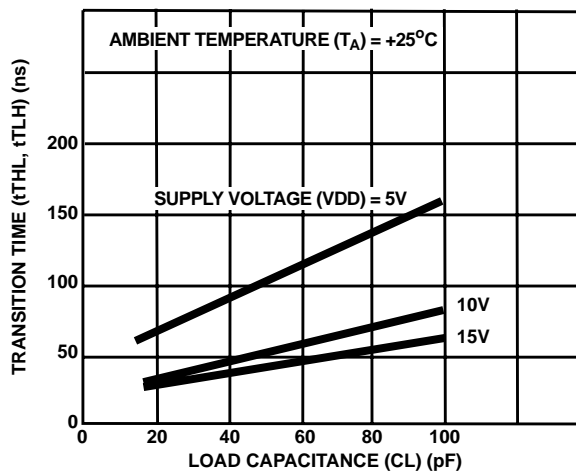


FIGURE 6. TYPICAL TRANSITION TIME AS A FUNCTION OF LOAD CAPACITANCE

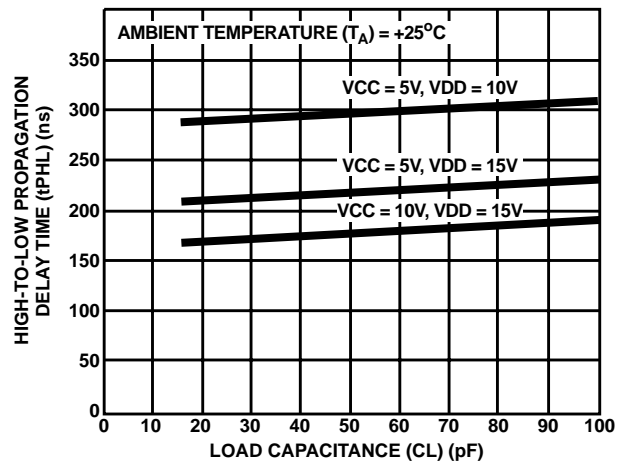


FIGURE 7. TYPICAL HIGH-TO-LOW PROPAGATION DELAY TIME AS A FUNCTION OF LOAD CAPACITANCE

Typical Performance Characteristics (Continued)

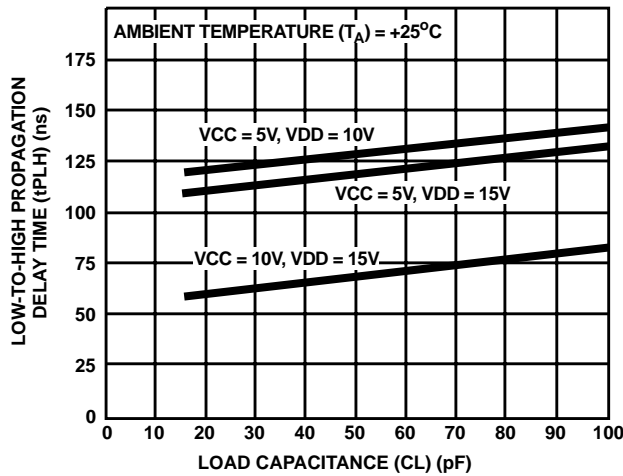


FIGURE 8. TYPICAL LOW-TO-HIGH PROPAGATION DELAY TIME AS A FUNCTION OF LOAD CAPACITANCE

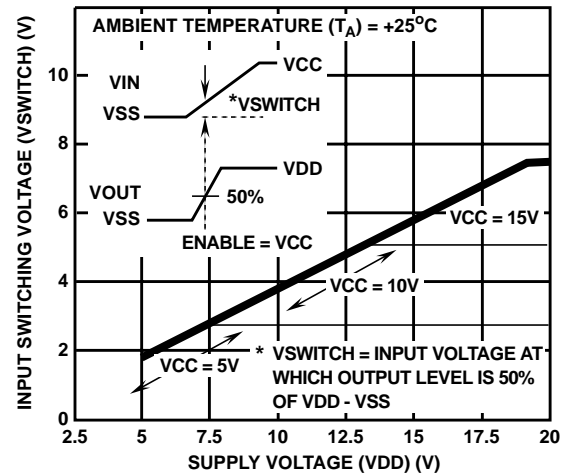


FIGURE 9. TYPICAL INPUT SWITCHING AS A FUNCTION OF HIGH LEVEL SUPPLY VOLTAGE

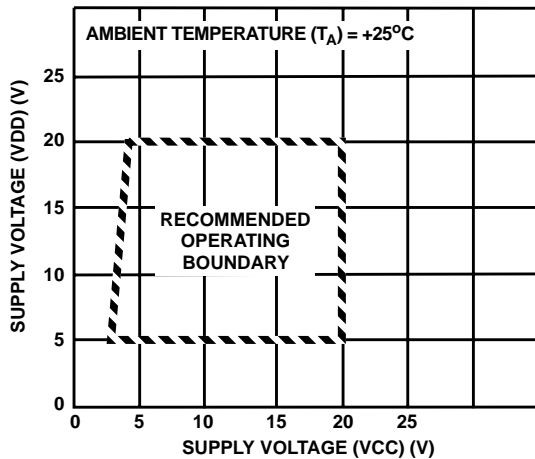


FIGURE 10. HIGH LEVEL SUPPLY VOLTAGE vs LOW LEVEL SUPPLY VOLTAGE

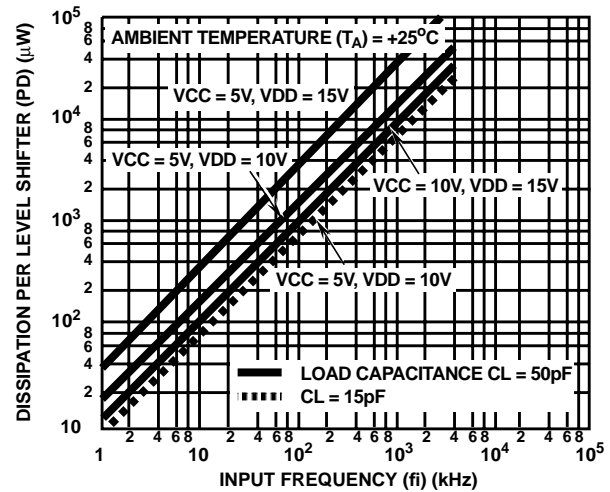


FIGURE 11. TYPICAL DYNAMIC POWER DISSIPATION AS A FUNCTION OF INPUT FREQUENCY

Test Circuit and Waveform

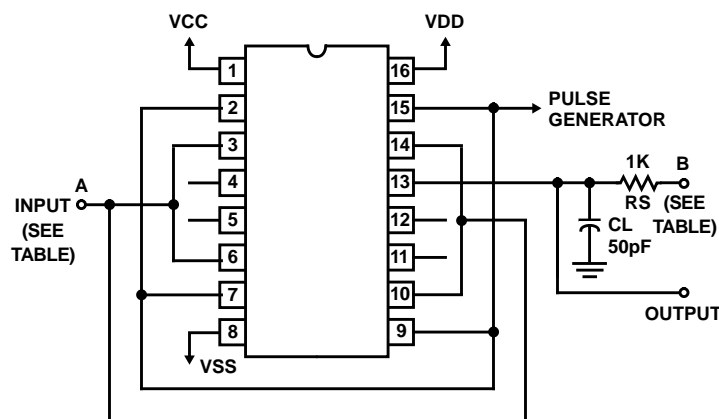
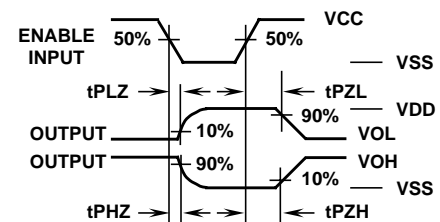
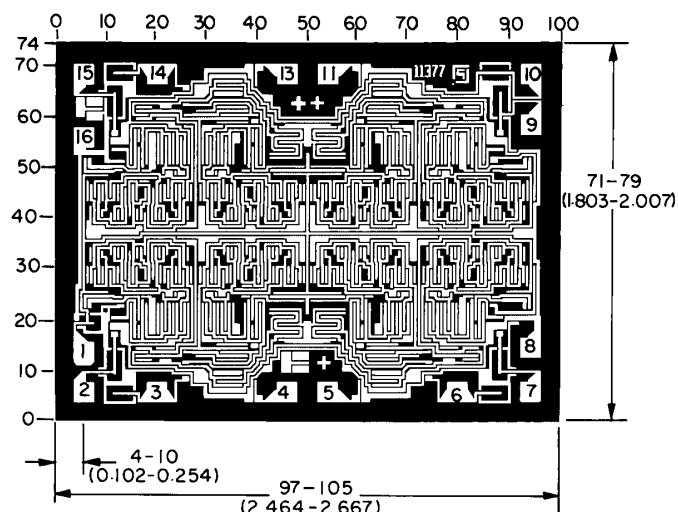


FIGURE 12. OUTPUT ENABLE DELAY TIMES TEST CIRCUIT AND WAVEFORMS

| CHAR | TEST VOLTAGE | |
|------|--------------|------|
| | AT A | AT B |
| tPHZ | VCC | VSS |
| tPLZ | VSS | VDD |
| tPZL | VSS | VDD |
| tPZH | VCC | VSS |



Chip Dimensions and Pad Layout



Dimensions in parenthesis are in millimeters and are derived from the basic inch dimensions as indicated. Grid graduations are in mils (10^{-3} inch).

METALLIZATION: Thickness: $11\text{k}\text{\AA} - 14\text{k}\text{\AA}$, AL.

PASSIVATION: $10.4\text{k}\text{\AA} - 15.6\text{k}\text{\AA}$, Silane

BOND PADS: 0.004 inches X 0.004 inches MIN

DIE THICKNESS: 0.0198 inches - 0.0218 inches

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Sales Office Headquarters

NORTH AMERICA

Intersil Corporation
P. O. Box 883, Mail Stop 53-204
Melbourne, FL 32902
TEL: (321) 724-7000
FAX: (321) 724-7240

EUROPE

Intersil SA
Mercure Center
100, Rue de la Fusee
1130 Brussels, Belgium
TEL: (32) 2.724.2111
FAX: (32) 2.724.22.05

ASIA

Intersil (Taiwan) Ltd.
Taiwan Limited
7F-6, No. 101 Fu Hsing North Road
Taipei, Taiwan
Republic of China
TEL: (886) 2 2716 9310
FAX: (886) 2 2715 3029